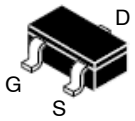
Field Effect Transistor - P-Channel, Logic Level, Enhancement Mode

NDS332P



SOT−23/SUPERSOT™ −23, 3 LEAD, 1.4x2.9
CASE 527AG

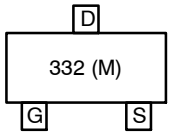
General Description

These P−Channel logic level enhancement mode power field effect transistors are produced using **onsemi**'s proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on−state resistance. These devices are particularly suited for low voltage applications such as notebook computer power management, portable electronics, and other battery powered circuits where fast high−side switching, and low in−line power loss are needed in a very small outline surface mount package.

Features

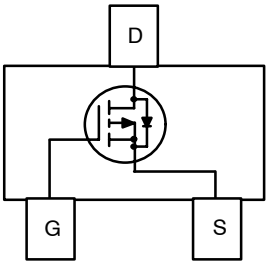
- −1 A, −20 V
  - $R_{DS(on)}$ = 0.41 Ω @ V_{GS} = −2.7 V
  - $R_{DS(on)}$ = 0.3 Ω @ V_{GS} = −4.5 V
- Very Low Level Gate Drive Requirements Allowing Direct Operation in 3 V Circuits. $V_{GS(th)}$ < 1.0 V
- Proprietary Package Design Using Copper Lead Frame for Superior Thermal and Electrical Capabilities
- High Density Cell Design for Extremely Low $R_{DS(ON)}$
- Exceptional On−resistance and Maximum DC Current Capability
- Compact Industry Standard SOT−23 Surface Mount Package
- This Devise is Pb−Free and Halide Free

MARKING DIAGRAM



332 = Specific device Code
M = Date Code

PIN ASSIGNMENT



ORDERING INFORMATION

Device	Package	Shipping†
NDS332P	SOT−23−3/ SUPERSOT−23 (Pb−Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Symbol	Parameter		Value	Unit
V_{DSS}	Drain−Source Voltage		−20	V
V_{GSS}	Gate−Source Voltage − Continuous		±8	V
I_D	Drain Current	Continuous (Note 1a)	−1	A
		Pulsed	−10	
P_D	Maximum Power Dissipation	(Note 1a)	0.5	W
		(Note 1b)	0.46	
T_J, T_{STG}	Operating and Storage Temperature Range		−55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Thermal Resistance, Junction−to−Ambient (Note 1a)	250	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction−to−Case (Note 1)	75	°C/W

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
BV_{DSS}	Drain–Source Breakdown Voltage	V_{GS} = 0 V, I_D = −250 μA	−20	–	–	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = −16 V, V_{GS} = 0 V	–	–	−1	μA
		V_{DS} = −16 V, V_{GS} = 0 V, T_J = 55°C	–	–	−10	
I_{GSS}	Gate–Body Leakage Current	V_{GS} = 8 V, V_{DS} = 0 V	–	–	100	nA
I_{GSS}	Gate–Body Leakage Current	V_{GS} = −8 V, V_{DS} = 0 V	–	–	−100	nA
ON CHARACTERISTICS (Note 2)						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = −250 μA	−0.4	−0.6	−1	V
		V_{DS} = V_{GS}, I_D = −250 μA, T_J = 125°C	−0.3	−0.45	−0.8	
$R_{DS(on)}$	Static Drain–Source On–Resistance	V_{GS} = −2.7 V, I_D = −1 A	–	0.35	0.41	Ω
		V_{GS} = −2.7 V, I_D = −1 A, T_J = 125°C	–	0.5	0.74	
		V_{GS} = −4.5 V, I_D = −1.1 A	–	0.26	0.3	
$I_{D(on)}$	On–State Drain Current	V_{GS} = −2.7 V, V_{DS} = −5 V	−1.5	–	–	A
		V_{GS} = −4.5 V, V_{DS} = −5 V	−2.5	–	–	
g_{FS}	Forward Transconductance	V_{DS} = −5 V, I_D = −1 A	–	2.2	–	S
DYNAMIC CHARACTERISTICS						
C_{iss}	Input Capacitance	V_{DS} = −10 V, V_{GS} = 0 V, f = 1.0 MHz	–	195	–	pF
C_{oss}	Output Capacitance		–	105	–	pF
C_{rss}	Reverse Transfer Capacitance		–	40	–	pF
SWITCHING CHARACTERISTICS (Note 2)						
$t_{d(on)}$	Turn–On Delay Time	V_{DD} = −6 V, I_D = −1 A, V_{GS} = −4.5 V, R_{GEN} = 6 Ω	–	8	15	ns
t_r	Turn–On Rise Time		–	30	45	ns
$t_{d(off)}$	Turn–Off Delay Time		–	25	45	ns
t_f	Turn–Off Fall Time		–	27	45	ns
Q_g	Total Gate Charge	V_{DS} = −5 V, I_D = −1 A, V_{GS} = −4.5 V	–	3.7	5	nC
Q_{gs}	Gate–Source Charge		–	0.5	–	nC
Q_{gd}	Gate–Drain Charge		–	0.9	–	nC
DRAIN–SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
I_S	Maximum Continuous Source Current		–	–	−0.42	A
V_{SD}	Drain–Source Diode Forward Voltage	V_{GS} = 0 V, I_S = −0.42 A (Note 2)	–	−0.75	−1.2	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. $R_{\theta JA}$ is the sum of the junction–to–case and case–to–ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.

$$P_D(t) = \frac{T_J - T_A}{R_{\theta JA}(t)} = \frac{T_J - T_A}{R_{\theta JC} + R_{\theta CA}(t)} = I_D^2(t) \times R_{DS(ON)\ @\ T_J}$$

Typical $R_{\theta JA}$ using the board layouts shown below on 4.5″ x 5″ FR–4 PCB in a still air environment:



a) 250°C/W when mounted on a 0.02 in^2 pad of 2oz copper.



b) 270°C/W when mounted on a 0.001 in^2 pad of 2oz copper.

2. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

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TYPICAL ELECTRICAL CHARACTERISTICS

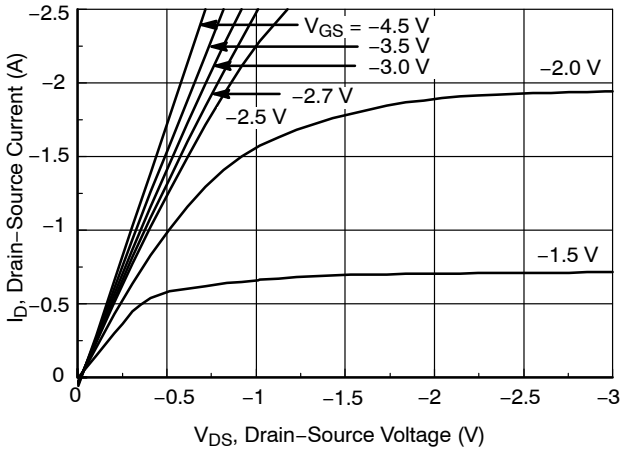

Figure 1. On−Region Characteristics

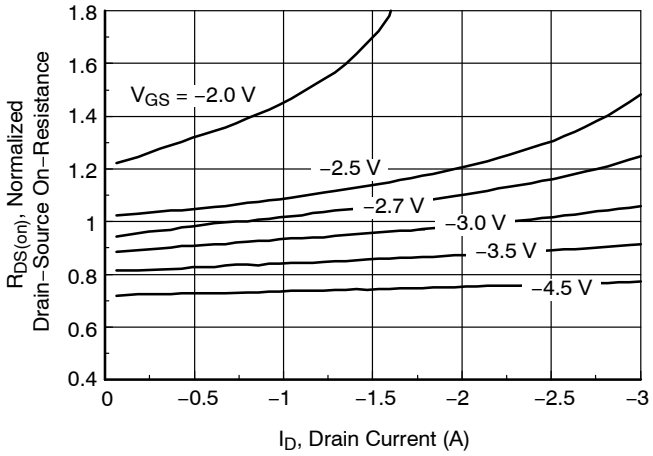

Figure 2. On−Resistance Variation with Drain Current and Gate Voltage

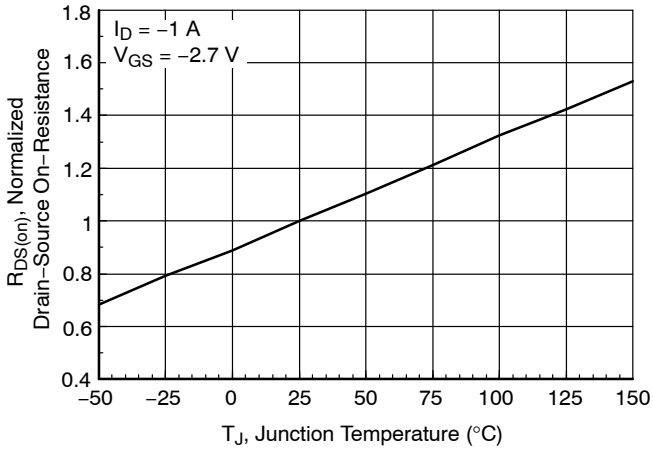

Figure 3. On−Resistance Variation with Temperature

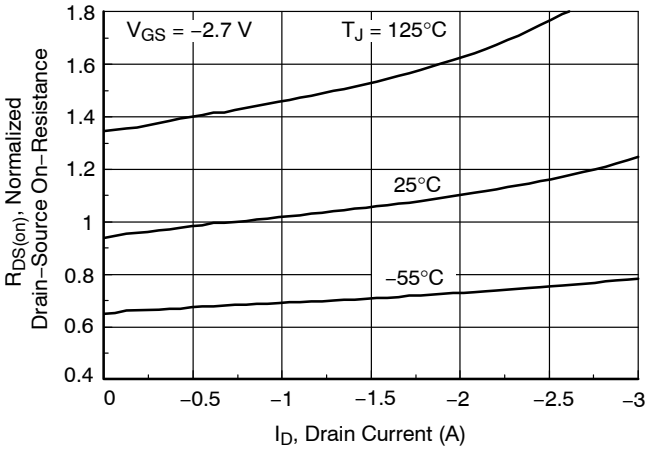

Figure 4. On−Resistance Variation with Drain Current and Temperature

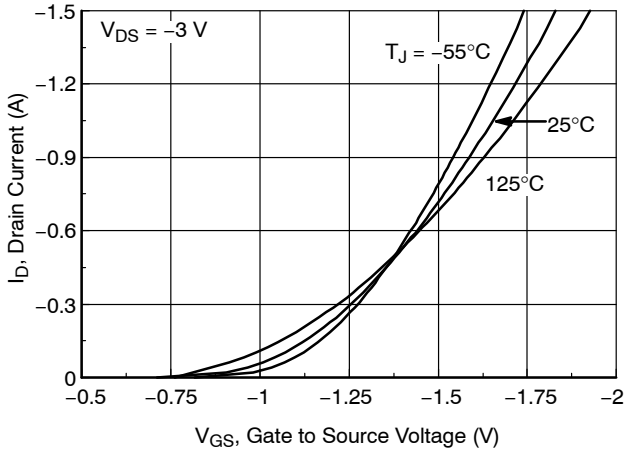

Figure 5. Transfer Characteristics

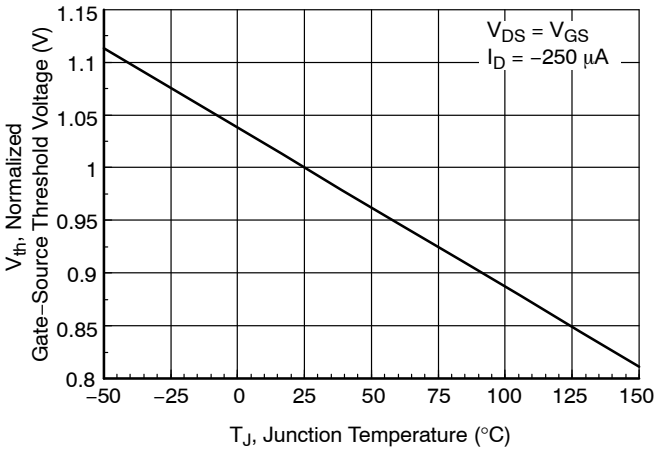

Figure 6. Gate Threshold Variation with Temperature

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TYPICAL ELECTRICAL CHARACTERISTICS (continued)

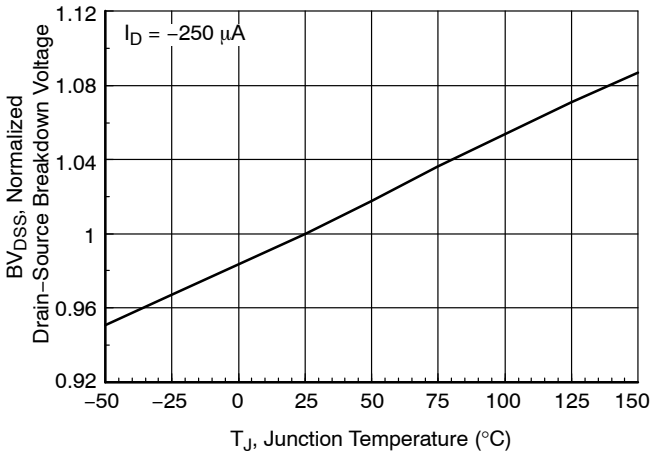

Figure 7. Breakdown Voltage Variation with Temperature

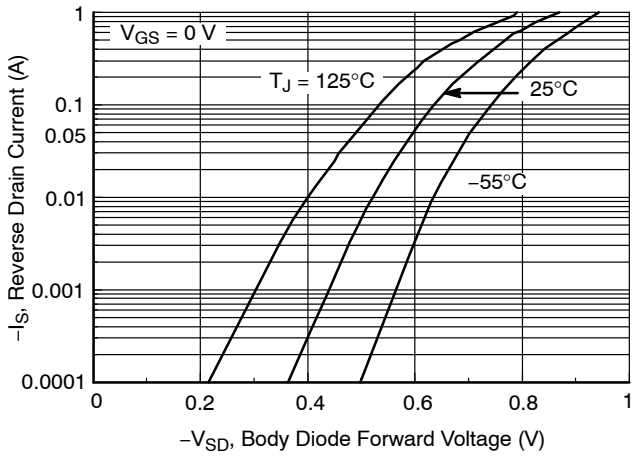

Figure 8. Body Diode Forward Voltage Variation with Source Current and Temperature

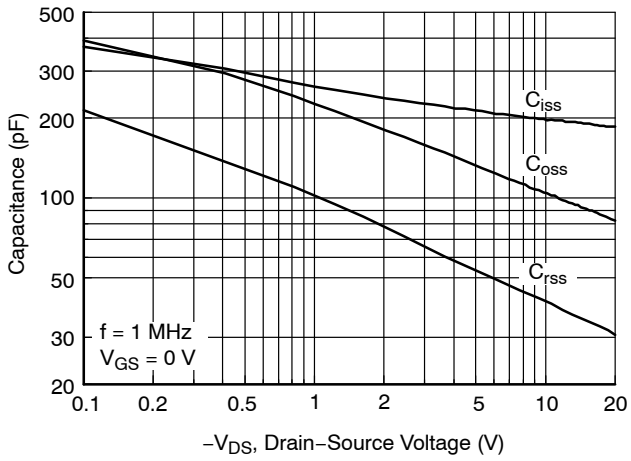

Figure 9. Capacitance Characteristics

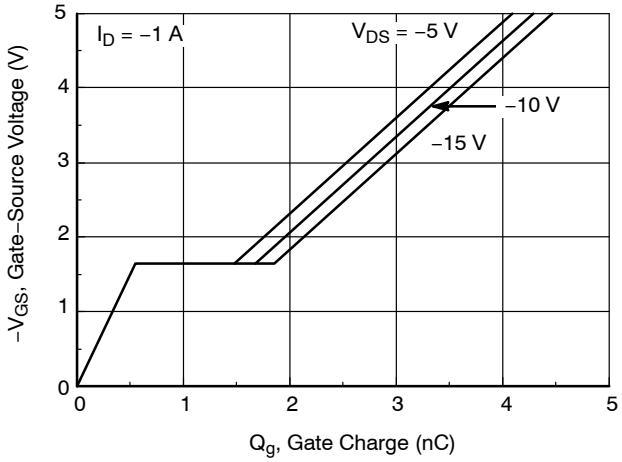

Figure 10. Gate Charge Characteristics

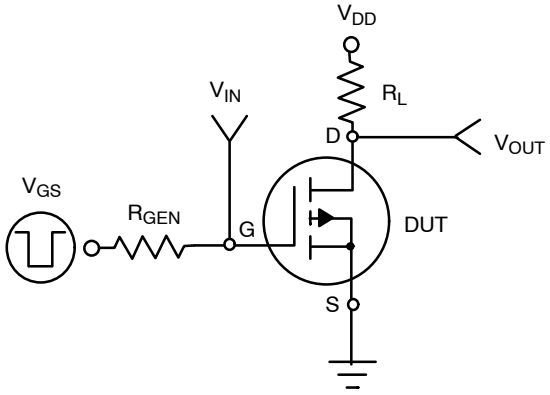

Figure 11. Switching Test Circuit

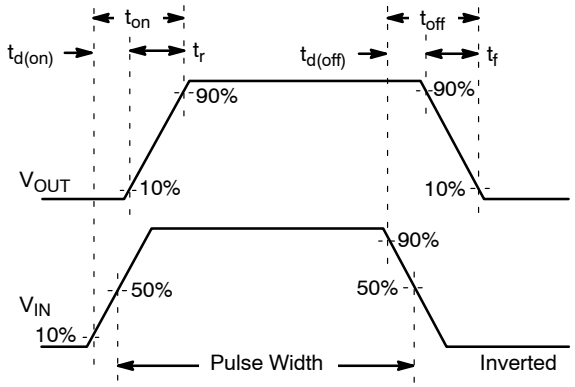

Figure 12. Switching Waveforms

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TYPICAL ELECTRICAL CHARACTERISTICS (continued)

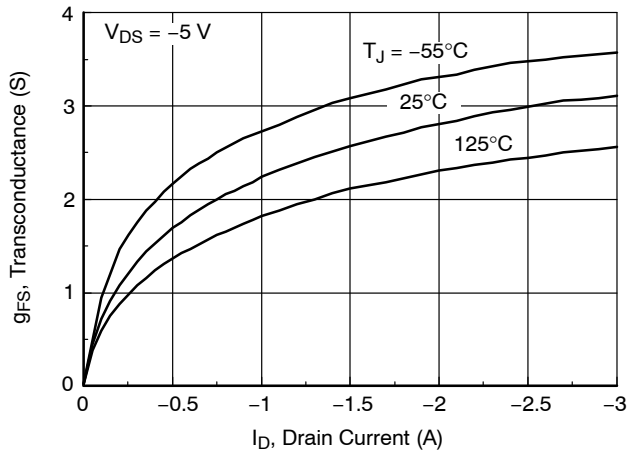

Figure 13. Transconductance Variation with Drain Current and Temperature

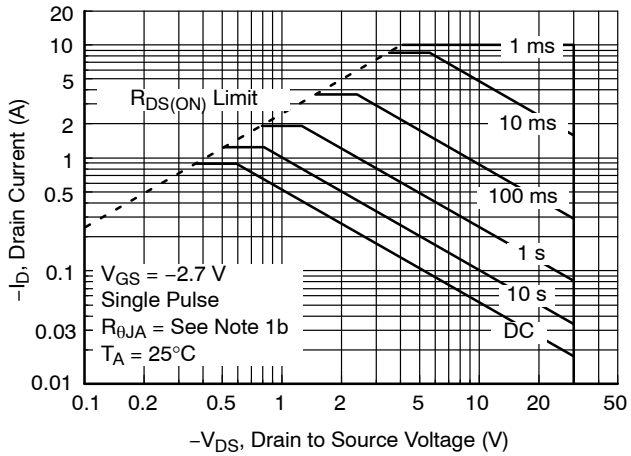

Figure 14. Maximum Safe Operating Area

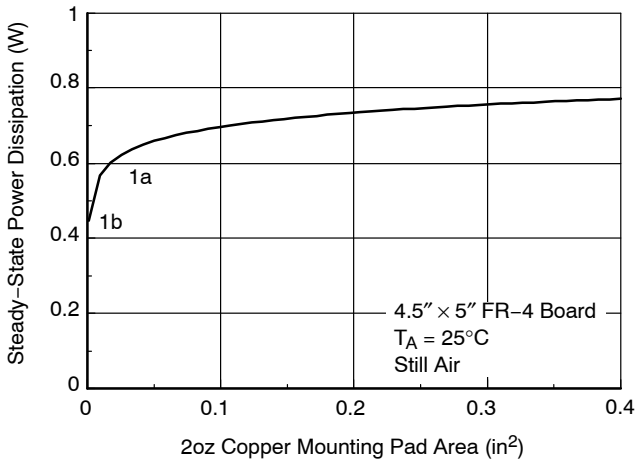

Figure 15. SUPERSOT™ −3 Maximum Steady−State Power Dissipation vs. Copper Mounting Pad Area

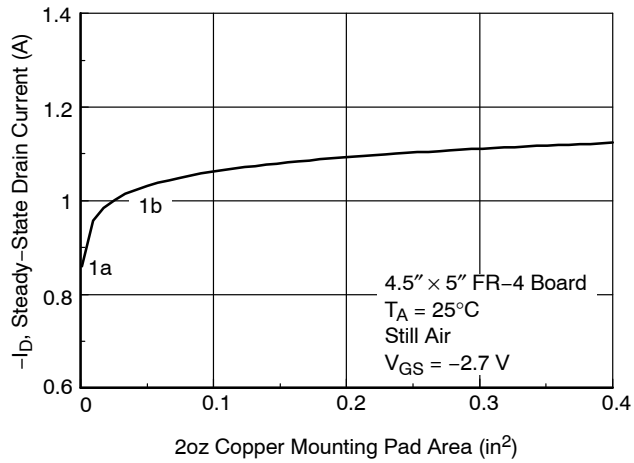

Figure 16. Maximum Steady−State Drain Current vs. Copper Mounting Pad Area

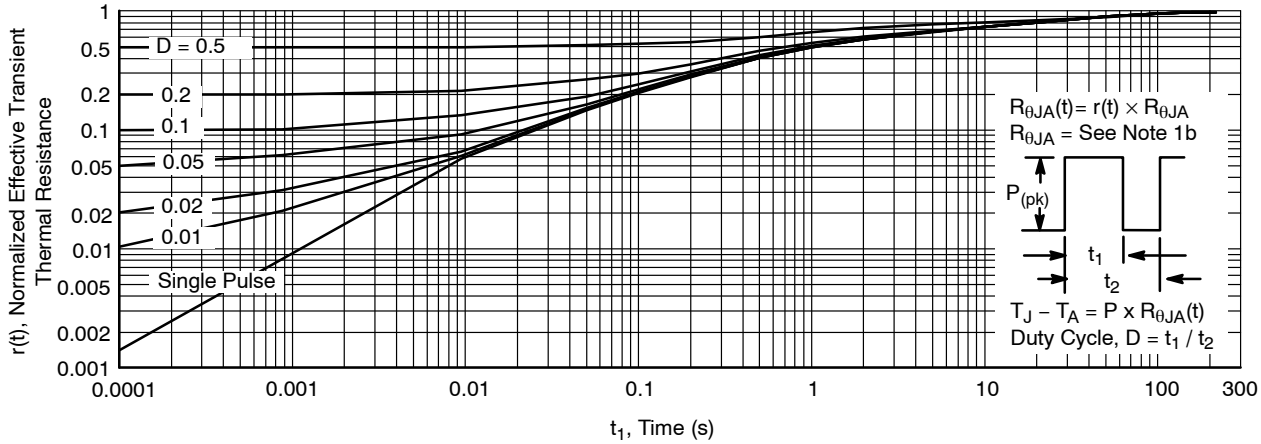

Figure 17. Transient Thermal Response Curve

Note: Characterization performed using the conditions described in note 1b.
Transient thermal response will change depending on the circuit board design.

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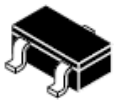

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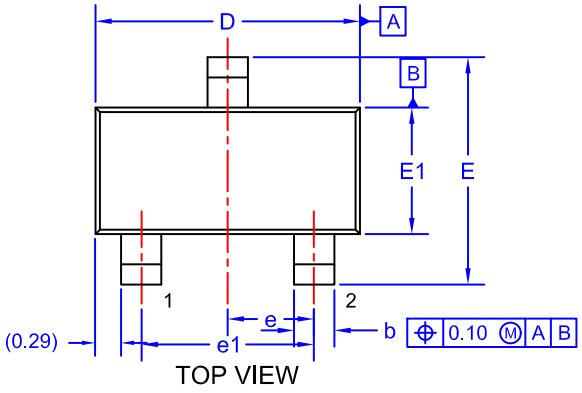
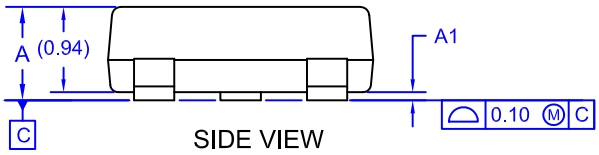


TOP VIEW

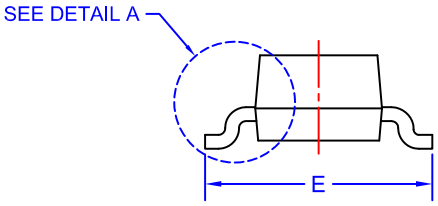
NOTES: UNLESS OTHERWISE SPECIFIED

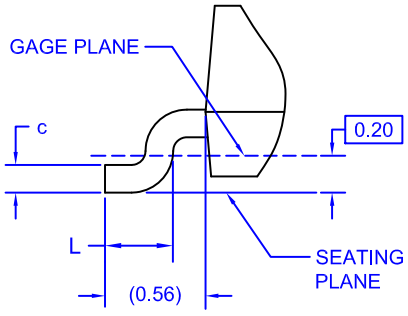
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
2. ALL DIMENSIONS ARE IN MILLIMETERS.
3. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.

DIM	MIN.	NOM.	MAX.
A	0.85	0.95	1.12
A1	0.00	0.05	0.10
b	0.370	0.435	0.508
c	0.085	0.150	0.180
D	2.80	2.92	3.04
E	2.31	2.51	2.71
E1	1.20	1.40	1.52
e	0.95 BSC		
e1	1.90 BSC		
L	0.33	0.38	0.43

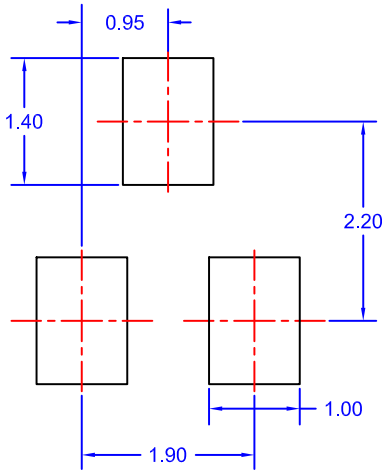


SIDE VIEW





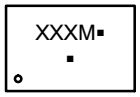
DETAIL A



LAND PATTERN RECOMMENDATION*

*FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code
M = Month Code
▪ = Pb−Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.

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Üretici parça numarasını yazın; stok ve fiyatı hemen görün.

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